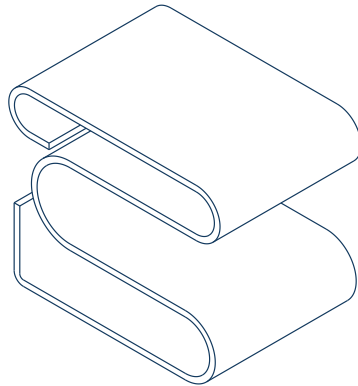




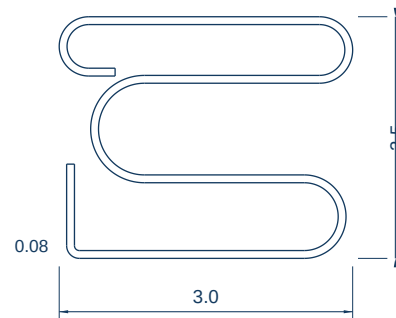
Type 3-03 B303-20030025

SMD EMI Spring Contact | Beryllium Copper | Units: mm

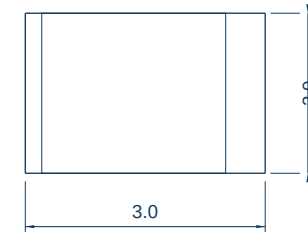
Isometric



Front view (mm)



Top view (mm)



MECHANICAL

VALUE

Thickness	0.08 mm
Width	2.0 mm +/- 0.2
Length	3.0 mm +/- 0.2
Height	2.5 mm +/- 0.2
Form	S-form: return hook, 3 plates, 4 folds, end lip
Bend radii	R0.263 CL, 180 deg R0.300 CL, 180 deg R0.508 CL, 180 deg
Developed length	13.90 mm
Base hole	none
Material / plating	BeCu, Gold-plated (G)
Volume / mass	2.223 mm ³ 18.6 mg (BeCu)
Product page	seyunda.com/type-3-03.html
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	B303-20030025G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 3.0x2.0x2.5mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf